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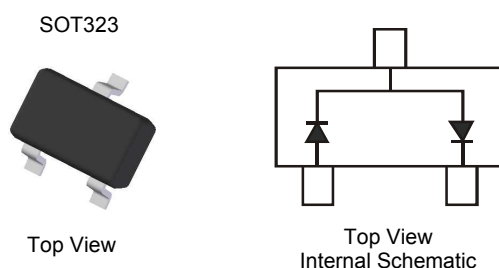
# HIGH VOLTAGE SURFACE MOUNT DUAL SWITCHING DIODE

## Features

- Fast Switching Speed: Maximum of 50ns
- High Reverse Breakdown Voltage: 300V
- Low Leakage Current: Maximum of 100nA when  $V_R = 240V$  at Room Temperature
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- Qualified to AEC-Q101 Standards for High Reliability**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Copper leadframe. (Lead Free Plating) Solderable per MIL-STD-202, Method 208③
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)

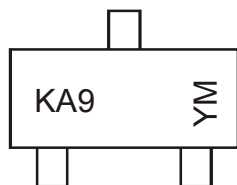


## Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
MMBD2004SW-7-F	Standard	SOT323	3000/Tape & Reel
MMBD2004SWQ-7-F	Automotive	SOT323	3000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  - See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  - For packaging details, go to our website at <http://www.diodes.com>.
  - Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

## Marking Information



KA9= Product Type Marking Code  
YM = Date Code Marking  
Y = Year (ex: B = 2014)  
M = Month (ex: 9 = September)

### Date Code Key

Year	2003	2004	.....	2013	2014	2015	2016	2017	2018	2019
Code	P	R	.....	A	B	C	D	E	F	G

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	300	V
Working Peak Reverse Voltage	V <sub>RWM</sub>	240	V
DC Blocking Voltage	V <sub>R</sub>		V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	170	V
Forward Continuous Current	I <sub>F</sub>	225	mA
Peak Repetitive Forward Current	I <sub>FRM</sub>	625	mA
Non-Repetitive Peak Forward Surge Current	I <sub>FSM</sub>	4.0	A
		1.0	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P <sub>D</sub>	250	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R <sub>θJA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	300	—	V	I <sub>R</sub> = 100μA
Forward Voltage	V <sub>F</sub>	—	0.87 1.0	V	I <sub>F</sub> = 20mA I <sub>F</sub> = 100mA
Peak Reverse Current (Note 7)	I <sub>R</sub>	—	100	nA μA	V <sub>R</sub> = 240V V <sub>R</sub> = 240V, T <sub>J</sub> = +150°C
Total Capacitance, per Element	C <sub>T</sub>	—	5.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	—	50	ns	I <sub>F</sub> = I <sub>R</sub> = 30mA, I <sub>rr</sub> = 3.0mA, R <sub>L</sub> = 100Ω

Notes: 6. Part mounted on FR-4 PC Board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.  
 7. Short duration pulse test used to minimize self-heating effect.

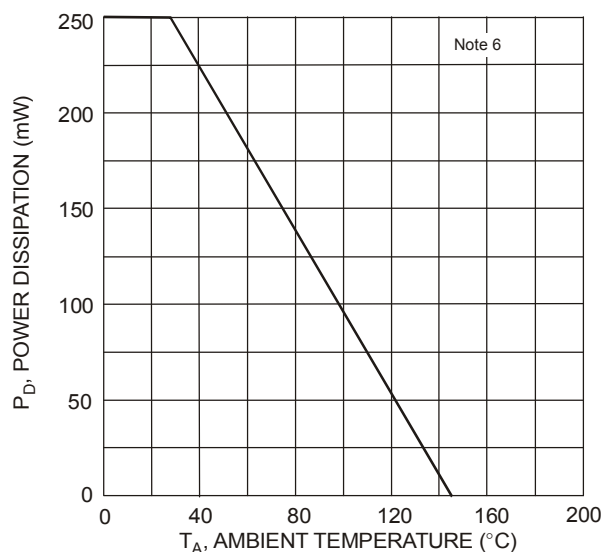


Figure 1 Power Derating Curve, Total Package

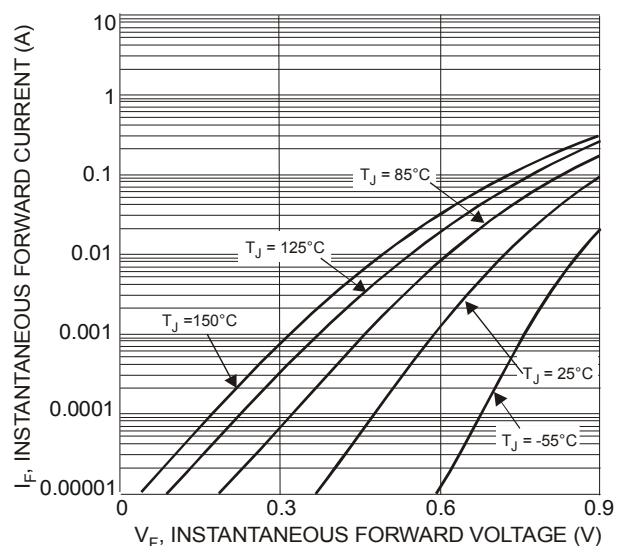


Figure 2 Typical Forward Characteristics, Per Element



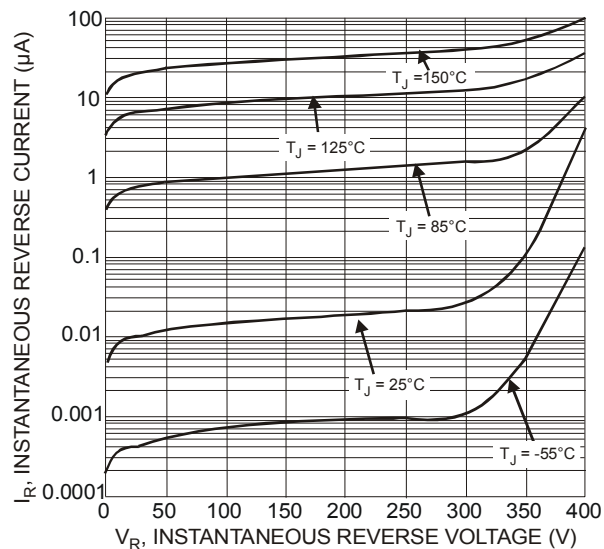


Figure 3 Typical Reverse Characteristics, Per Element

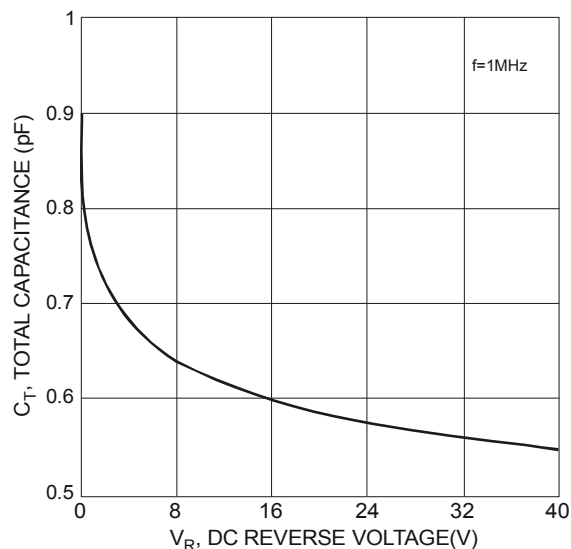
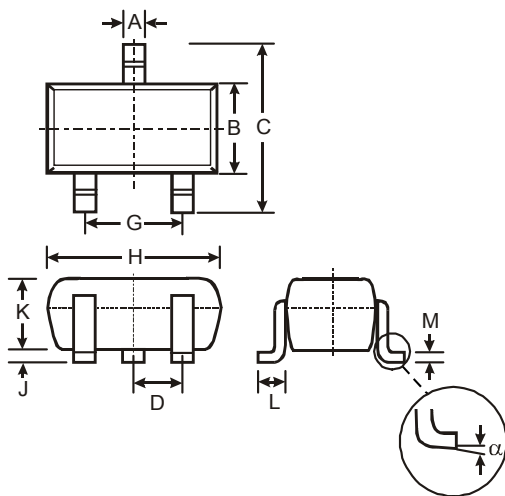


Figure 4 Total Capacitance vs. Reverse Voltage, Per Element

## Package Outline Dimensions

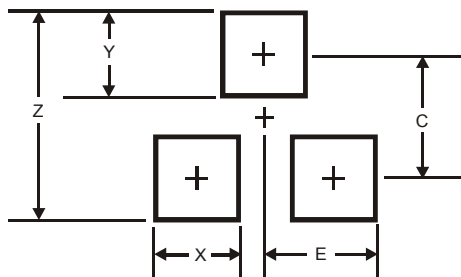
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT323			
Dim	Min	Max	Typ
A	0.25	0.40	0.30
B	1.15	1.35	1.30
C	2.00	2.20	2.10
D	-	-	0.65
G	1.20	1.40	1.30
H	1.80	2.20	2.15
J	0.0	0.10	0.05
K	0.90	1.00	1.00
L	0.25	0.40	0.30
M	0.10	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.8
X	0.7
Y	0.9
C	1.9
E	1.0

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